International Rectifier

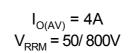
4GBU Series

4.0 Amps Single Phase Full Wave

Bridge Rectifier

Features

- Diode chips are glass passivated
- Suitable for Universal hole mounting
- Easy to assemble & install on P.C.B.
- High Surge Current Capability
- High Isolation between terminals and molded case (1500 V_{RMS})
- Lead free terminals solderable as per MIL-STD-750 Method 2026
- Terminals suitable for high temperature soldering at 260°C for 8-10 secs
- UL E215862 approved

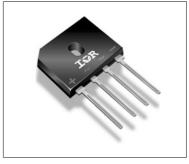


Description

These GBU Series of Single Phase Bridges consist of four glass passivated silicon junction connected as a Full Wave Bridge. These four junctions are encapsulated by plastic molding technique. These Bridges are mainly used in Switch Mode power supply and in industrial and consumer equipment.

Major Ratings and Characteristics

_			
Parameters		4GBU	Units
Io		4	Α
	@T _C	100	°C
I _{FSM}	@50Hz	150	А
	@60Hz	158	Α
I ² t	@ 50Hz	113	A ² s
	@60Hz	104	A ² s
V_{RRM}	range	50 to 800	V
T _J		- 55 to 150	°C



4GBU

4GBU Series

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ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{RRM} , max repetitive peak rev. voltage $T_J = T_J max$.	V _{RMS} , max RMS voltage T _J = T _J max. V	I _{RRM} max. @ rated V _{RRM} Τ _J = 25°C μΑ	I _{RRM} max. @ rated V _{RRM} T _J = 150°C μΑ
4GBU	005	50	35	5	400
4GBUF	01	100	70	5	400
	02	200	140	5	400
	04	400	280	5	400
	06	600	420	5	400
	08	800	560	5	400

Forward Conduction

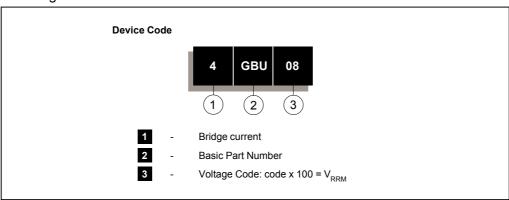
	Parameters	4GBU	Unit	Conditions	
Io	Maximum DC output current	4	Α	T _C = 100°C, Re	sistive & inductive load
		3.2		T _C =100°C, Ca	pacitive load
I _{FSM}	Maximum peak, one-cycle	150		t = 10ms	
	non-repetitive surge current,				
	following any rated load condition	158		t = 8.3ms	T _J =150°C
	and with rated V _{RRM} reapplied				
I ² t	Maximum I ² t for fusing,	113	A ² s	t = 10ms	
	initial T _J =T _J max	104		t = 8.3ms	
V _{FM}	Maximum peak forward voltage	1.0	V	T_I=25°C, I _{FM} =4A	
	per diode				
I _{RM}	Typical peak reverse leakage	5	μA	T _J =25°C, 100% V _{RRM}	
	current per diode				
V_{RRM}	Maximum repetitive peak	50 to 800	V		
	reverse voltage range				

Thermal and Mechanical Specifications

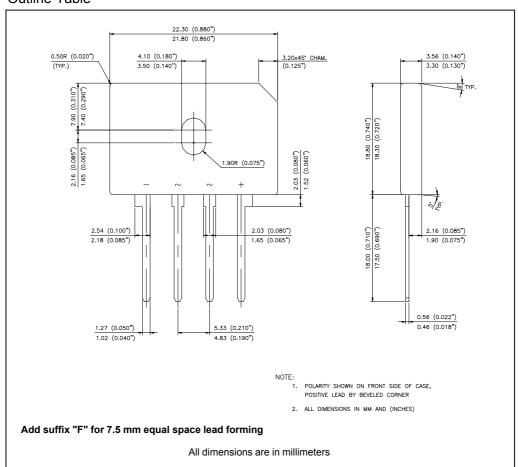
	Parameters	4GBU	Unit	Conditions
T _J	Operating and storage	-55 to 150	°C	
T _{stg}	temperature range			
R _{thJC}	Max. thermal resistance	4.2	°C/W	DC rated current through bridge (1)
	junction to case			
R_{thJA}	Thermal resistance,	22	°C/W	DC rated current through bridge (1)
	junction to ambient			
W	Approximateweight	4(0.14)	g (oz)	
Т	MountingTorque	1.0	Nm	Bridge to Heatsink
		9.0	Lb.in	

Note (1): Devices mounted on 40x 40x1.5mm aluminum plate; use silicon thermal compound for maximum heat transfer and bolt down using 3mm screw

Ordering Information Table



Outline Table



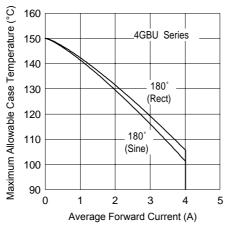


Fig. 1 - Current Ratings Characteristics

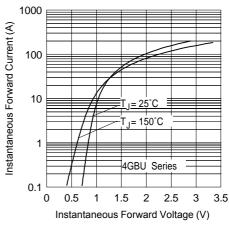


Fig. 2 - Forward Voltage Drop Characteristics

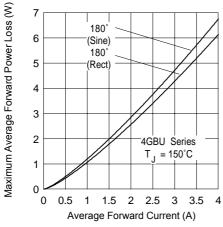


Fig. 3 - Total Power Loss Characteristics

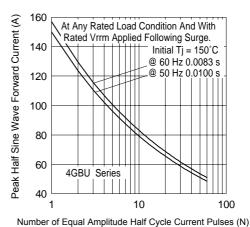


Fig. 4 - Maximum Non-Repetitive Surge Current

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Data and specifications subject to change without notice. This product has been designed and qualified for Multiple Level.

Qualification Standards can be found on IR's Web site.



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